

# GSM1330S

## 60V N-Channel Enhancement Mode MOSFET

### Product Description

GSM1330S, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent  $R_{DS(ON)}$ , low gate charge.

These devices are particularly suited for low voltage power management, such as smart phone and notebook computer and other battery powered circuits, and low in-line power loss are needed in commercial industrial surface mount applications.

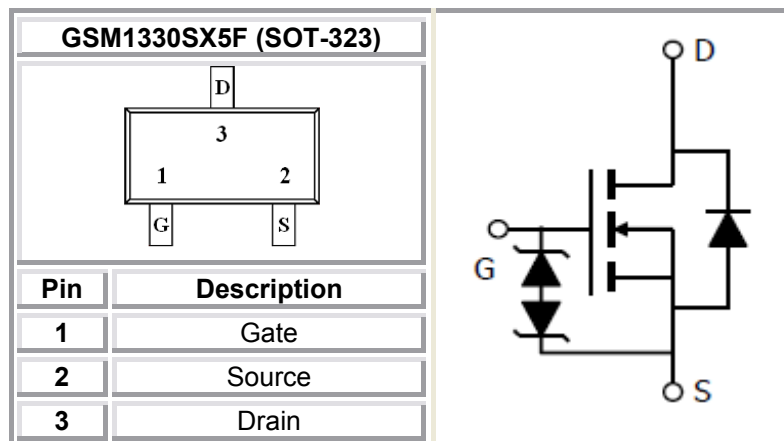
### Features

- 60V/0.5A ,  $R_{DS(ON)} = 7.5\Omega @ V_{GS} = 10V$
- 60V/0.05A ,  $R_{DS(ON)} = 7.5\Omega @ V_{GS} = 5V$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- ESD Protected ( 1KV ) Diode design-in
- SOT-323(SC-70) package design

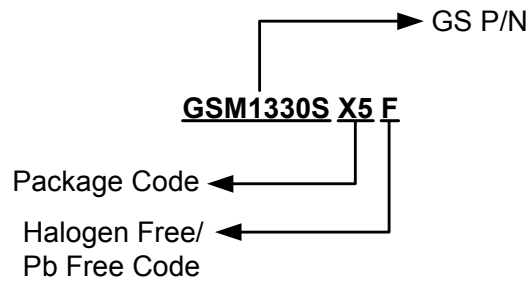
### Applications

- Drivers: Relays, Solenoids, Lamps, Hammers, Display, Memories, Transistors, etc.
- High saturation current capability. Direct Logic-Level Interface: TTL/CMOS
- Battery Operated Systems
- Solid-State Relays

### Packages & Pin Assignments

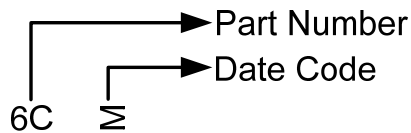


## Ordering Information



Part Number	Package	Quantity
GSM1330SX5F	SOT-323	3000 PCS

## Marking Information



## Absolute Maximum Ratings

T<sub>A</sub>=25°C Unless otherwise noted

Symbol	Parameter	Typical	Unit
V <sub>DSS</sub>	Drain-Source Voltage	60	V
V <sub>GSS</sub>	Gate-Source Voltage	±20	V
I <sub>D</sub>	Continuous Drain Current(T <sub>J</sub> =150°C)	T <sub>A</sub> =25°C	0.115
		T <sub>A</sub> =70°C	0.075
I <sub>DM</sub>	Pulsed Drain Current	0.8	A
I <sub>S</sub>	Continuous Source Current(Diode Conduction)	0.115	A
P <sub>D</sub>	Power Dissipation	T <sub>A</sub> =25°C	0.225
T <sub>J</sub>	Operating Junction Temperature	150	°C
T <sub>STG</sub>	Storage Temperature Range	-55/150	°C
R <sub>θJA</sub>	Thermal Resistance-Junction to Ambient	417	°C/ W

## Electrical Characteristics

T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	60			V
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	1.0	1.6	2.0	V
I <sub>GSS</sub>	Gate Leakage Current	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			3	uA
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> = 60V, V <sub>GS</sub> =0V			1	uA
		V <sub>DS</sub> = 60V, V <sub>GS</sub> =0V, T <sub>J</sub> =85°C			10	
R <sub>DS(on)</sub>	Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =0.5A		1.4	7.5	Ω
		V <sub>GS</sub> =5V, I <sub>D</sub> =0.05A		1.8	7.5	
g <sub>fs</sub>	Forward Transconductance	V <sub>DS</sub> =10V, I <sub>D</sub> =0.2A	80			mS
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =0.115A, V <sub>GS</sub> =0V			1.5	V
<b>Dynamic</b>						
C <sub>iss</sub>	Input Capacitance	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1MHz		17	50	pF
C <sub>oss</sub>	Output Capacitance			10	25	
C <sub>rss</sub>	Reverse Transfer Capacitance			3	5	
t <sub>d(on)</sub>	Turn-On Time	V <sub>DD</sub> =25V, R <sub>L</sub> =50Ω, I <sub>D</sub> =0.5A, V <sub>GEN</sub> =10V, R <sub>G</sub> =25Ω		7	20	ns
t <sub>d(off)</sub>	Turn-Off Time			11	40	

## Typical Characteristics

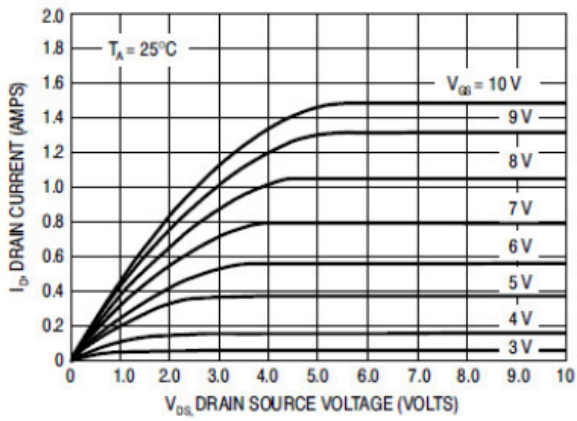


Figure 1. Ohmic Region

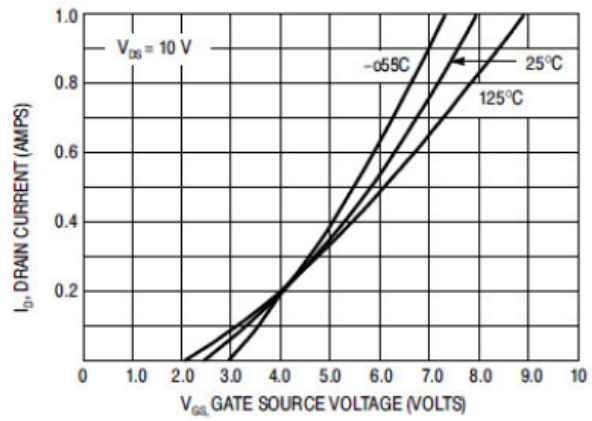


Figure 2. Transfer Characteristics

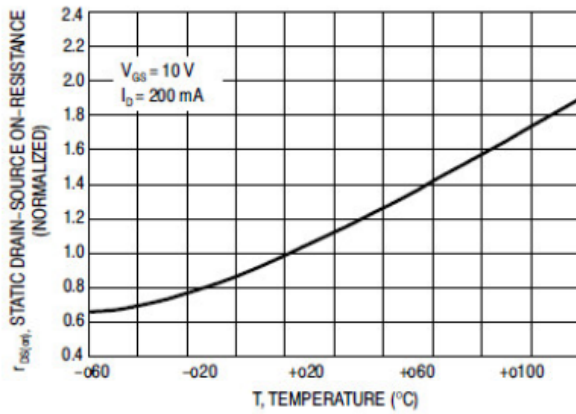


Figure 3. Temperature versus Static Drain-Source On-Resistance

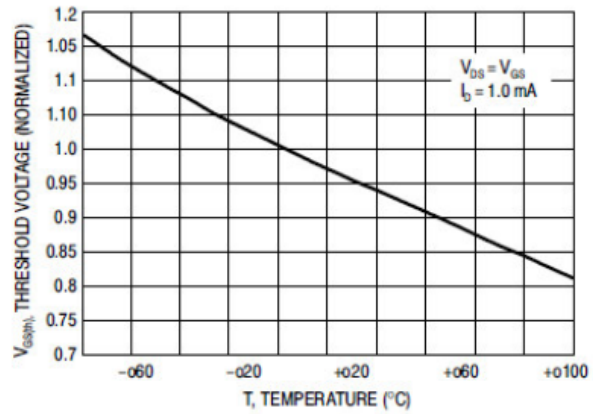
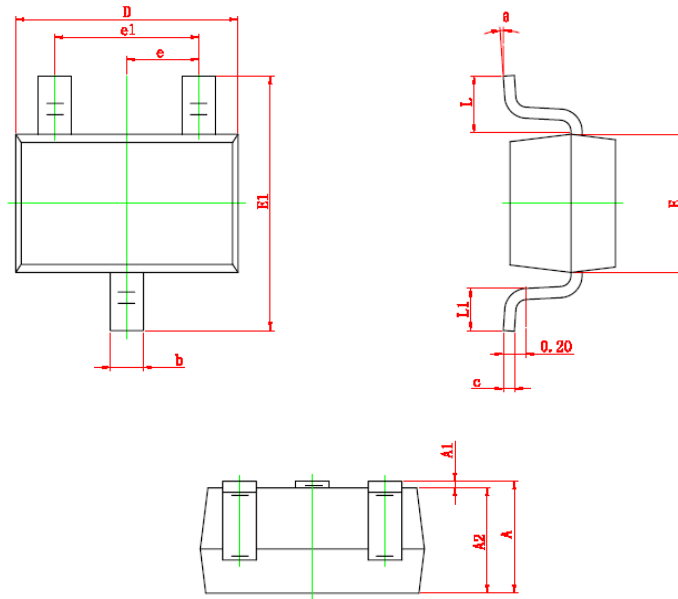


Figure 4. Temperature versus Gate Threshold Voltage

## Package Dimension

### SOT-323 PLASTIC PACKAGE







Dimensions				
Symbol	Millimeters		Inches	
	Min	Max	Min	Max
<b>A</b>	0.900	1.100	0.035	0.043
<b>A1</b>	0.000	0.100	0.000	0.004
<b>A2</b>	0.900	1.000	0.035	0.039
<b>b</b>	0.200	0.400	0.008	0.016
<b>c</b>	0.080	0.150	0.003	0.006
<b>D</b>	2.000	2.200	0.079	0.087
<b>E</b>	1.150	1.350	0.045	0.053
<b>E1</b>	2.150	2.450	0.085	0.096
<b>e</b>	0.650 TYP		0.026 TYP	
<b>e1</b>	1.200	1.400	0.047	0.055
<b>L</b>	0.525 REF		0.021 REF	
<b>L1</b>	0.260	0.460	0.010	0.018
<b>θ</b>	0°	8°	0°	8°



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